

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7MPB9307FT/FK

Low Voltage/Low Power 8-Bit Dual Supply Bus Switch

The TC7MPB9307 is a CMOS 8-bit dual-supply bus switch that can provide an interface between two nodes at different voltage levels.

The TC7MPB9307 can be connected to two independent power supplies. VCCA supports 1.8-V, 2.5-V and 3.3-V power supplies, whereas VCCB supports 2.5-V, 3.3-V and 5.0V power supplies.

Bidirectional level-shifting is possible by simply adding external pull-up resistors between the An/Bn data lines and the VCCA/VCCB supplies. There is no restriction on the relative magnitude of the An and Bn voltages; both the An and Bn data lines can be pulled up to arbitrary power supplies.

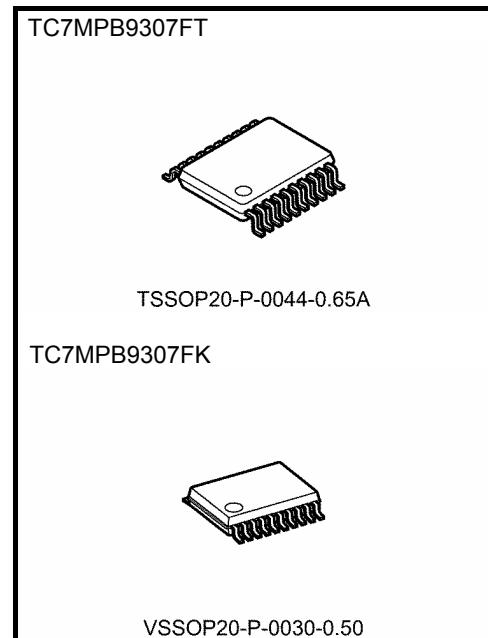
The Output Enable (\overline{OE}) input controls the connection or isolation of two bus systems on the VCCA and VCCB sides.

The \overline{OE} input is common for all the eight bits of the data lines; thus the TC7MPB9307 is used as a single eight-bit bus switch. When \overline{OE} is Low, the switch is on, and An is connected to Bn. When \overline{OE} is High, the switch is open.

The TC7MPB9307 supports power-down protection at the \overline{OE} input, with \overline{OE} being 5.5-V tolerant.

The channels consist of n-type MOSFETs.

All the inputs provide protection against electrostatic discharge.

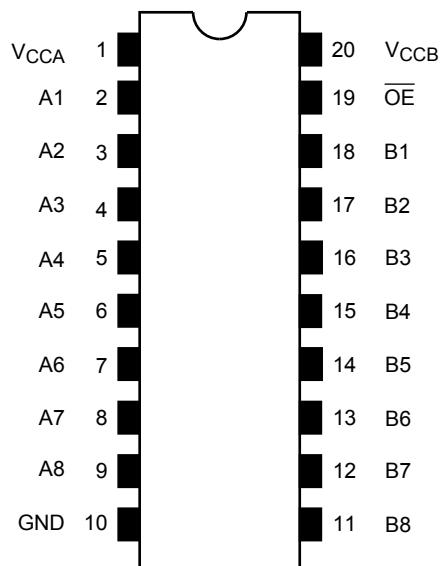


Weight
 TSSOP20-P-0044-0.65A : 0.08 g (typ.)
 VSSOP20-P-0030-0.50 : 0.03 g (typ.)

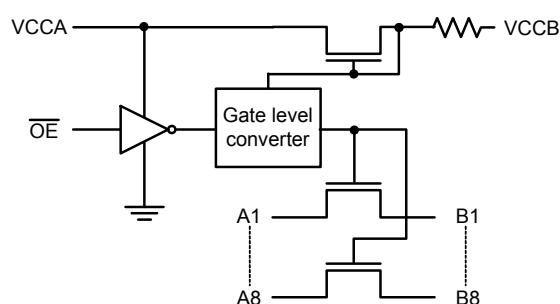
Features

- Operating voltage: 1.8-V to 2.5-V, 1.8-V to 3.3-V, 1.8-V to 5.0-V, 2.5-V to 3.3-V, 2.3-V to 5.0-V or 3.3-V to 5.0-V bidirectional interface
- Operating voltage: VCCA = 1.65 to 5.0 V, VCCB = 2.3 to 5.5 V
- Low ON-resistance: $RON = 5.0 \Omega$ (typ.)
(ON-resistance test circuit: $V_{IS} = 0$ V, $I_{IS} = 30$ mA, $V_{CCA} = 3.0$ V, $V_{CCB} = 4.5$ V)
- ESD performance: Machine model $\geq \pm 200$ V
Human body model $\geq \pm 2000$ V
- 5.5-V tolerance and power-down protection at the Output Enable input.
- Packages: TSSOP20, VSSOP(20)

Start of commercial production
2007-11

Pin Assignment (top view)**Truth Table**

Inputs	Function
\overline{OE}	
L	A port = B port
H	Disconnect

Circuit Schematic

Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{CCA}	−0.5 to 7.0	V
	V _{CCB}	−0.5 to 7.0	
Control input voltage	V _{IN}	−0.5 to 7.0	V
Switch input/output voltage	V _S	−0.5 to 7.0	V
Clump diode current	I _{IK}	−50	mA
Switch input/output current	I _S	64	mA
DC V _{CC} /ground current per supply pin	I _{CCA}	±25	mA
	I _{CCB}	±25	
Power dissipation	P _D	180	mW
Storage temperature	T _{stg}	−65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage (Note 2)	V _{CCA}	1.65 to 5.0	V
	V _{CCB}	2.3 to 5.5	
Control input voltage	V _{IN}	0 to 5.5	V
Switch input/output voltage	V _S	0 to 5.5	V
Operating temperature	T _{opr}	−40 to 85	°C
Control input rise and fall times	dt/dv	0 to 10	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs and bus inputs must be tied to either V_{CCA} or GND.

Note 2: The V_{CCA} voltage must be lower than the V_{CCB} voltage.

Application Circuit

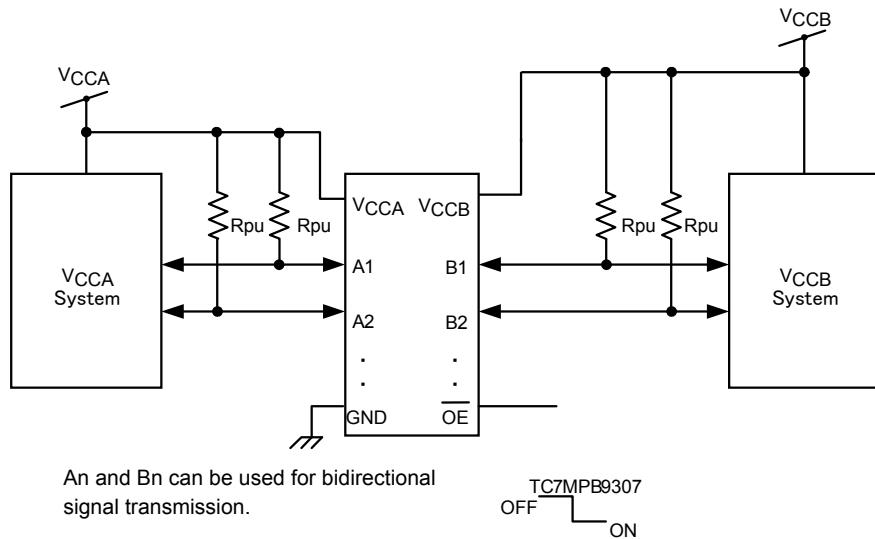


Figure 1 Application Circuit Diagram

The V_{CCA} voltage must be lower than the V_{CCB} voltage.

Level-shifting functionality is enabled by adding pull-up resistors from A_n to V_{CCA} or V_{CCB} and from B_n to V_{CCB} or V_{CCA} , respectively.

Electrical Characteristics

DC Characteristics ($T_a = -40$ to 85°C)

Characteristics		Symbol	Test Condition	V_{CCA} (V)	V_{CCB} (V)	$T_a = -40$ to 85°C		Unit	
						Min	Max		
Control input voltage	High-level	V_{IH}	—	$1.65 \leq V_{CCA} < 2.3$	V_{CCA} to 5.5	$0.8 \times V_{CCA}$	—	V	
				$2.3 \leq V_{CCA} < 5.0$	V_{CCA} to 5.5	$0.7 \times V_{CCA}$	—		
	Low-level	V_{IL}	—	$1.65 \leq V_{CCA} < 2.3$	V_{CCA} to 5.5	—	$0.2 \times V_{CCA}$		
				$2.3 \leq V_{CCA} < 5.0$	V_{CCA} to 5.5	—	$0.3 \times V_{CCA}$		
ON-resistance (Note)		R_{ON}	$V_{IS} = 0\text{V}$, $I_{IS} = 30\text{mA}$ (Figure 2)	1.65	2.3	—	16.0	Ω	
				2.3	3.0	—	11.0		
				3.0	4.5	—	8.0		
Power off leakage current	I_{OFF}	$A_n, B_n = 0$ to 5.5V (per circuit)		0	0	—	± 1.0	μA	
Switch-off leakage current	I_{SZ}	$A_n, B_n = 0$ to 5.5V $\overline{OE} = V_{CCA}$, $OE = GND$		1.65 to 5.0	V_{CCA} to 5.5	—	± 1.0	μA	
Control input current	I_{IN}	$\overline{OE} = 0$ to 5.5V		1.65 to 5.0	V_{CCA} to 5.5	—	± 1.0	μA	
leakage current from V_{CCB} to V_{CCA}	I_{CCBA}	$\overline{OE} = 0$ or V_{CCA} $V_{CCB} \rightarrow V_{CCA}$		3.3	5.0	—	50.0	μA	
Quiescent supply current	I_{CCA1}	$\overline{OE} = V_{CCA}$ or GND , $I_S = 0\text{A}$		1.65 to 5.0	V_{CCA}	—	10.0	μA	
	I_{CCB1}	$\overline{OE} = V_{CCA}$ or GND , $I_S = 0\text{A}$		1.65 to 5.0	V_{CCA}	—	10.0		
	I_{CCA2}	$V_{CCA} \leq \overline{OE} \leq 5.5\text{ V}$, $I_S = 0\text{A}$		1.65 to 5.0	V_{CCA}	—	± 10.0		
	I_{CCB2}	$V_{CCA} \leq \overline{OE} \leq 5.5\text{ V}$, $I_S = 0\text{A}$		1.65 to 5.0	V_{CCA}	—	± 10.0		

Note: ON-resistance is measured by measuring the voltage drop across the switch at the indicated current.

Level Shift Characteristics ($T_a = -40$ to 85°C)

Characteristics	Symbol	Test Condition	V_{CCA} (V)	V_{CCB} (V)	$T_a = -40$ to 85°C		Unit
					Min	Max	
Input/Output Characteristics (Up Translation) (Note 1)	V_{OHU}	$A_n = V_{IN}$ $SW = ON$ (Figure 7)	1.65	3.0 to 5.5	1.4	—	V
			2.3	4.5 to 5.5	2.05	—	
			3.0	4.5 to 5.5	2.7	—	
Input/Output Characteristics (Down Translation) (Note 2)	V_{OHD}	$A_n = V_{CCA}$ $SW = ON$ (Figure 9)	1.65	3.3 to 5.5	1.3	1.65	
			2.3	4.5 to 5.5	1.95	2.3	
			3.0	4.5 to 5.5	2.6	3.0	

Note 1: The Input/Output Characteristics for up translation indicate the input voltages required to provide $V_{CCA} + 0.5\text{ V}$ on the outputs when measured using the test circuitry shown in Figure 7.

Note 2: The Input/Output Characteristics for down translation indicate the voltages that cause the output voltages to saturate when measured using the test circuitry shown in Figure 9.

AC Characteristics (Ta = -40 to 85°C, Input: $t_r = t_f = 2.0$ ns, f=10kHz)**V_{CCA}= 3.3 ± 0.3 V, V_{CCB}= 5.0 ± 0.5 V**

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time (Bus to Bus)	t_{PLH}	Figures 3 and 5 (Note)	—	0.3	ns
Propagation delay time (Bus to Bus)	t_{PHL}	Figures 3 and 5 (Note)	—	1.2	
Output enable time	t_{PZL}	Figures 4 and 6	—	9.0	
Output disable time	t_{PLZ}	Figures 4 and 6	—	11.0	

Note: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On resistance of the switch and the 30 pF load capacitance, when driven by an ideal voltage the source (zero output impedance).

V_{CCA}= 2.5 ± 0.2 V, V_{CCB}= 5.0 ± 0.5 V

Characteristics	記号	Test Condition	Min	Max	Unit
Propagation delay time (Bus to Bus)	t_{PLH}	Figures 3 and 5 (Note)	—	0.35	ns
Propagation delay time (Bus to Bus)	t_{PHL}	Figures 3 and 5 (Note)	—	1.8	
Output enable time	t_{PZL}	Figures 4 and 6	—	13.0	
Output disable time	t_{PLZ}	Figures 4 and 6	—	15.0	

Note: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On resistance of the switch and the 30 pF load capacitance, when driven by an ideal voltage the source (zero output impedance).

V_{CCA} = 2.5 ± 0.2 V, V_{CCB}= 3.3 ± 0.3 V

Characteristics	記号	Test Condition	Min	Max	Unit
Propagation delay time (Bus to Bus)	t_{PLH}	Figures 3 and 5 (Note)	—	0.45	ns
Propagation delay time (Bus to Bus)	t_{PHL}	Figures 3 and 5 (Note)	—	2.2	
Output enable time	t_{PZL}	Figures 4 and 6	—	17.0	
Output disable time	t_{PLZ}	Figures 4 and 6	—	19.0	

Note: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On resistance of the switch and the 30 pF load capacitance, when driven by an ideal voltage the source (zero output impedance).

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	V _{CCA} (V)	V _{CCB} (V)	Typ.	Unit
			V _{CCA} (V)	V _{CCB} (V)		
Control input capacitance	C_{IN}	SW=ON	3.3	3.3	3	pF
Switch input/output capacitance	$C_{I/O}$		3.3	3.3	14	
		SW=OFF	3.3	3.3	7	

DC Test Circuit

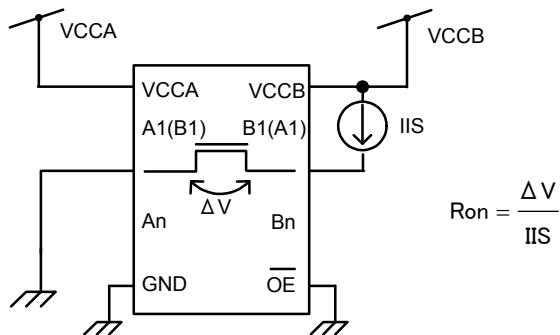


Figure 2 ON-resistance Test Circuits

AC Test Circuits

• tpLH, HL

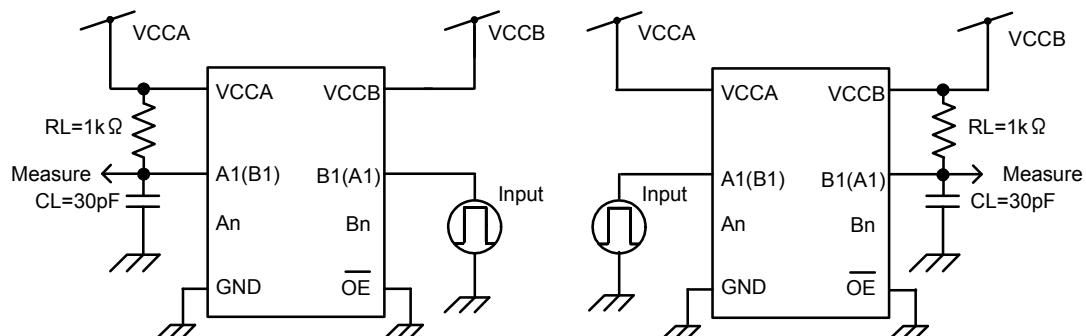


Figure 3 tpLH, tpHL Test Circuits

• tpLZ, ZL

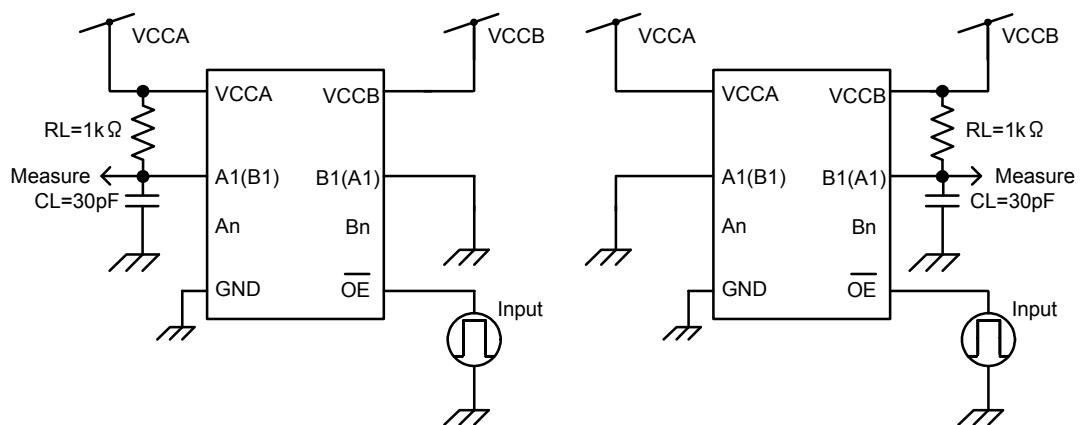


Figure 4 tpLZ, tpZL Test Circuits

AC Waveform

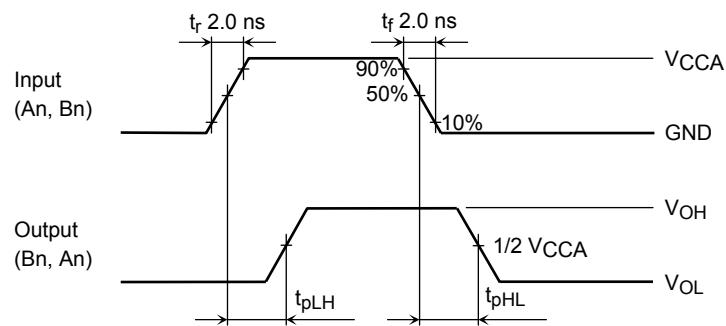


Figure 5 tpLH, tpHL

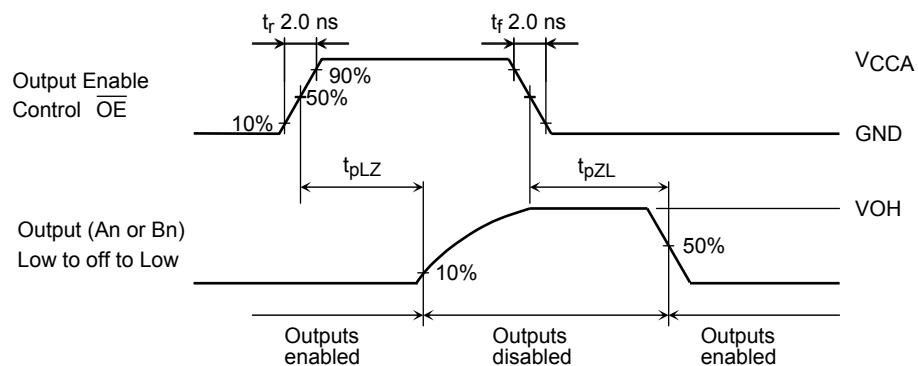


Figure 6 tpLZ, tpZL

Level Shift Function (Used Pull-up Resistance)

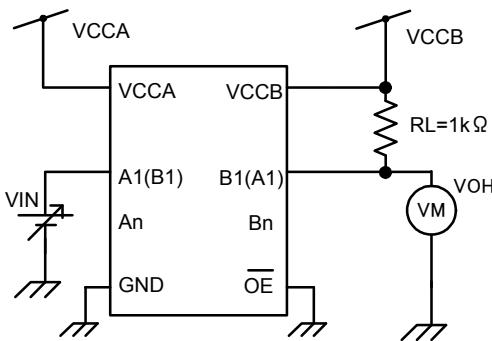


Figure 7 Test Circuit

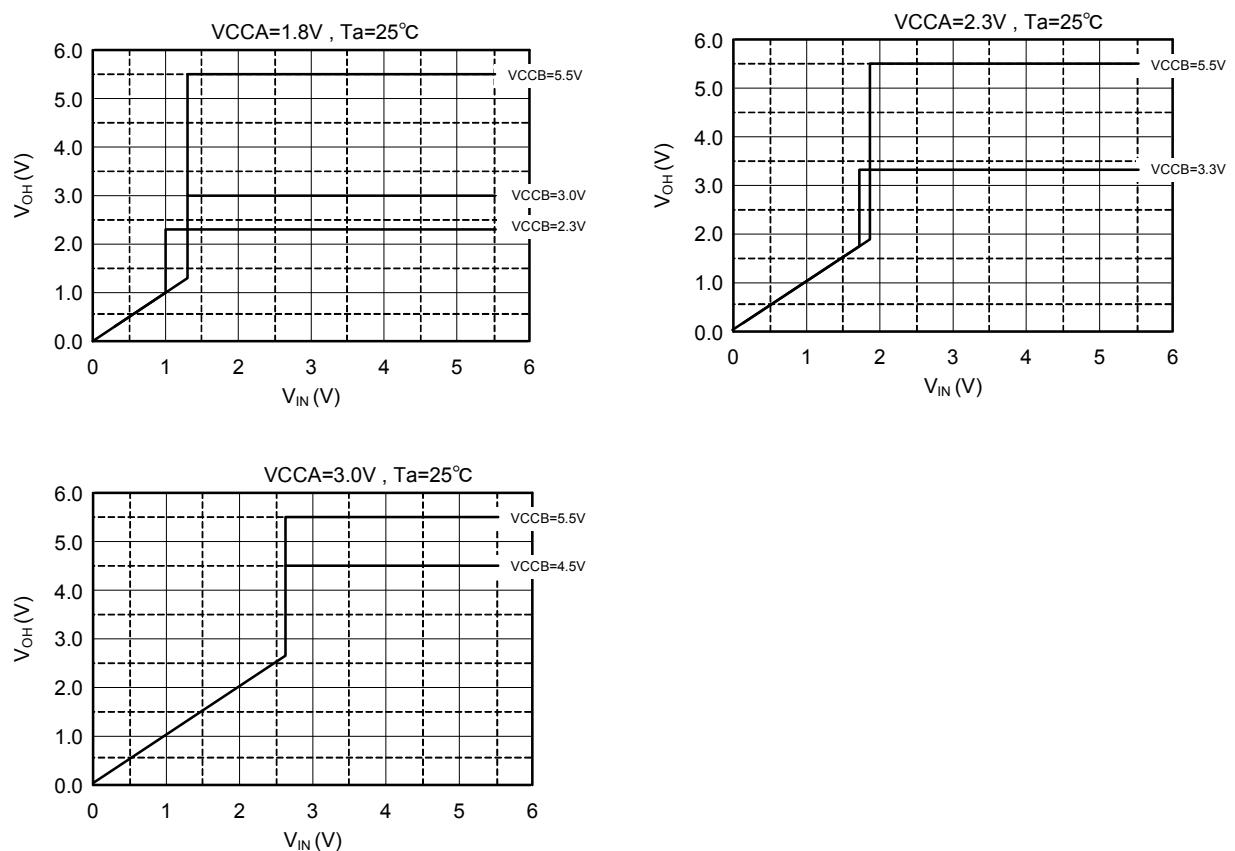


Figure 8 Input/Output Characteristics (Typ.)

Level Shift Function (Unused Pull-up Resistance)

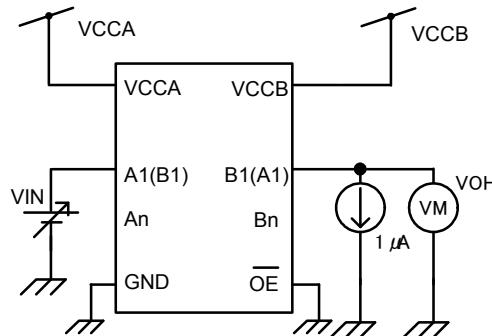


Figure 9 Test Circuit

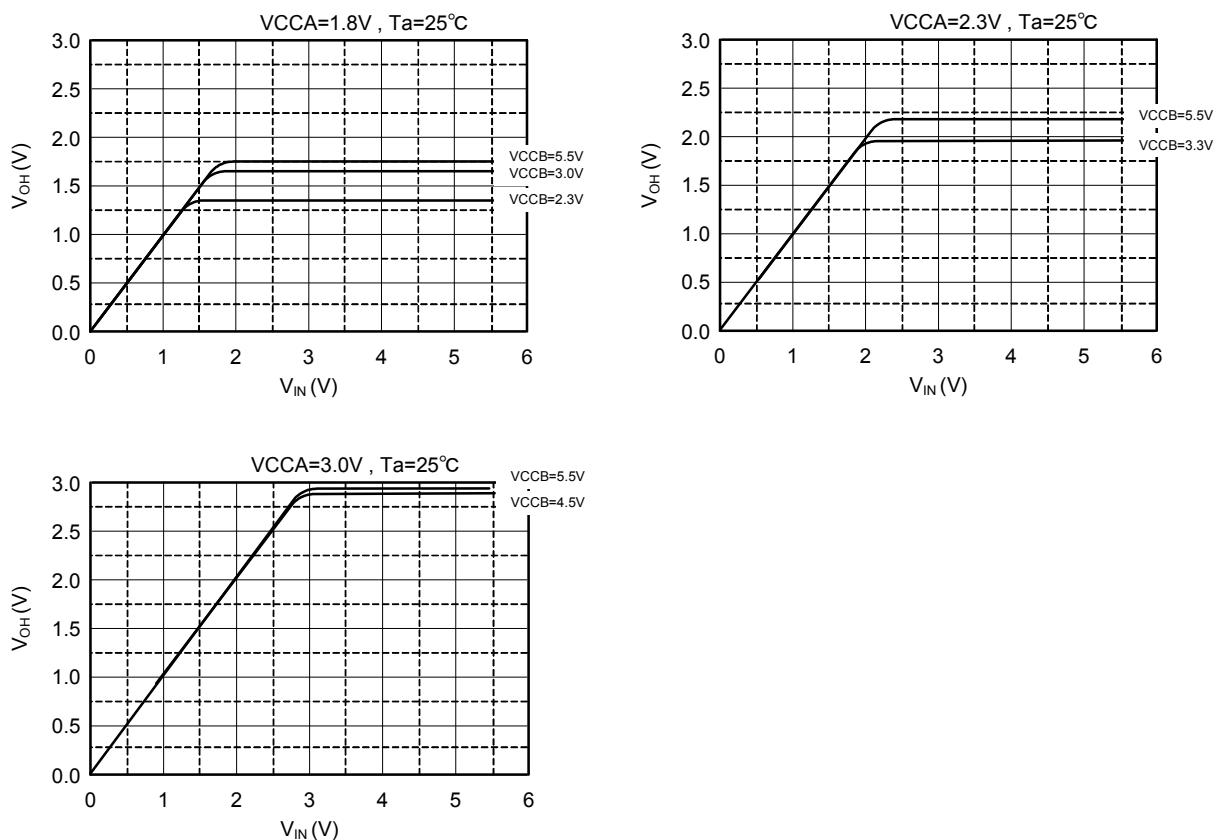
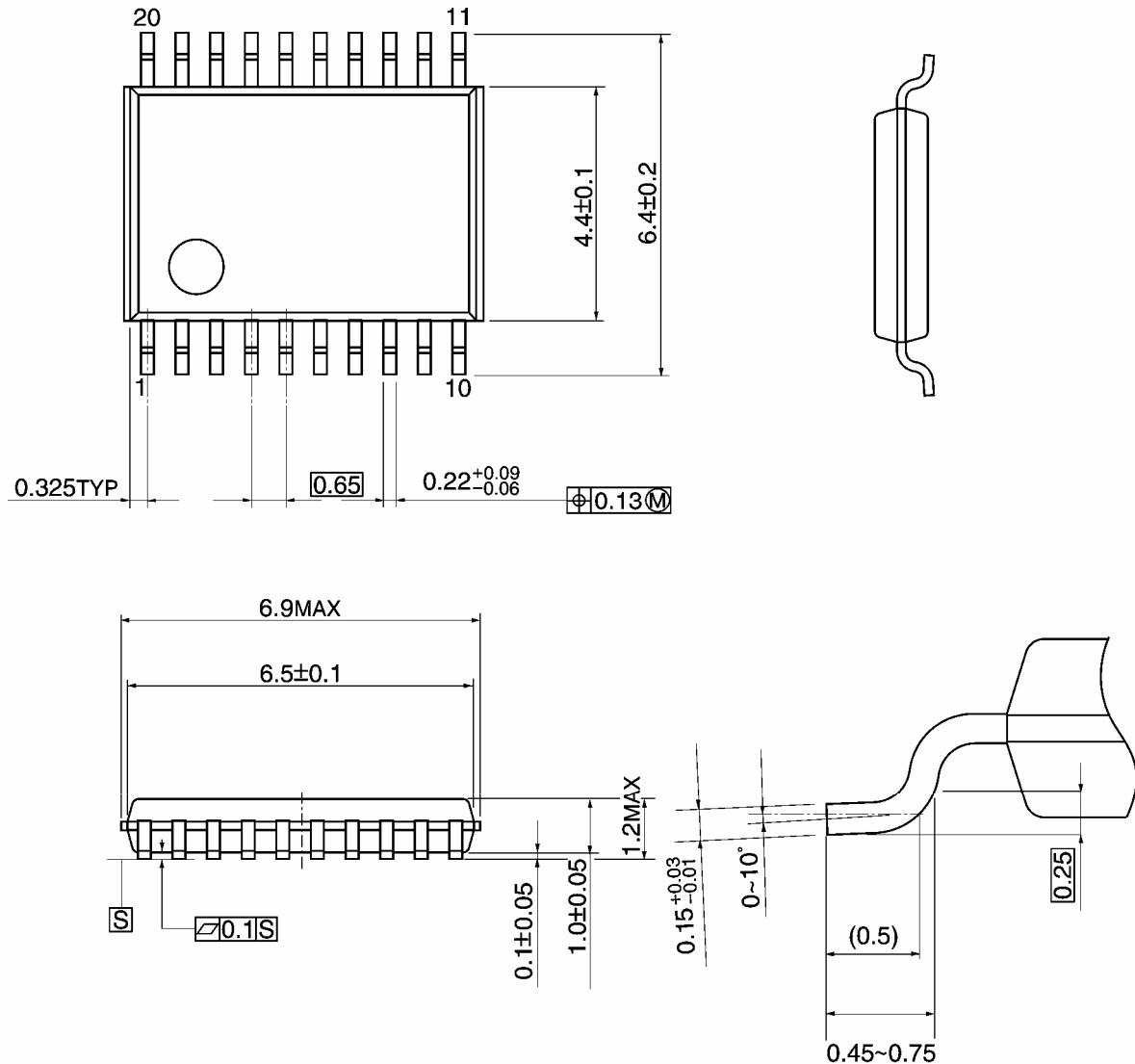


Figure 10 Input/Output Characteristics (Typ.)

Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm

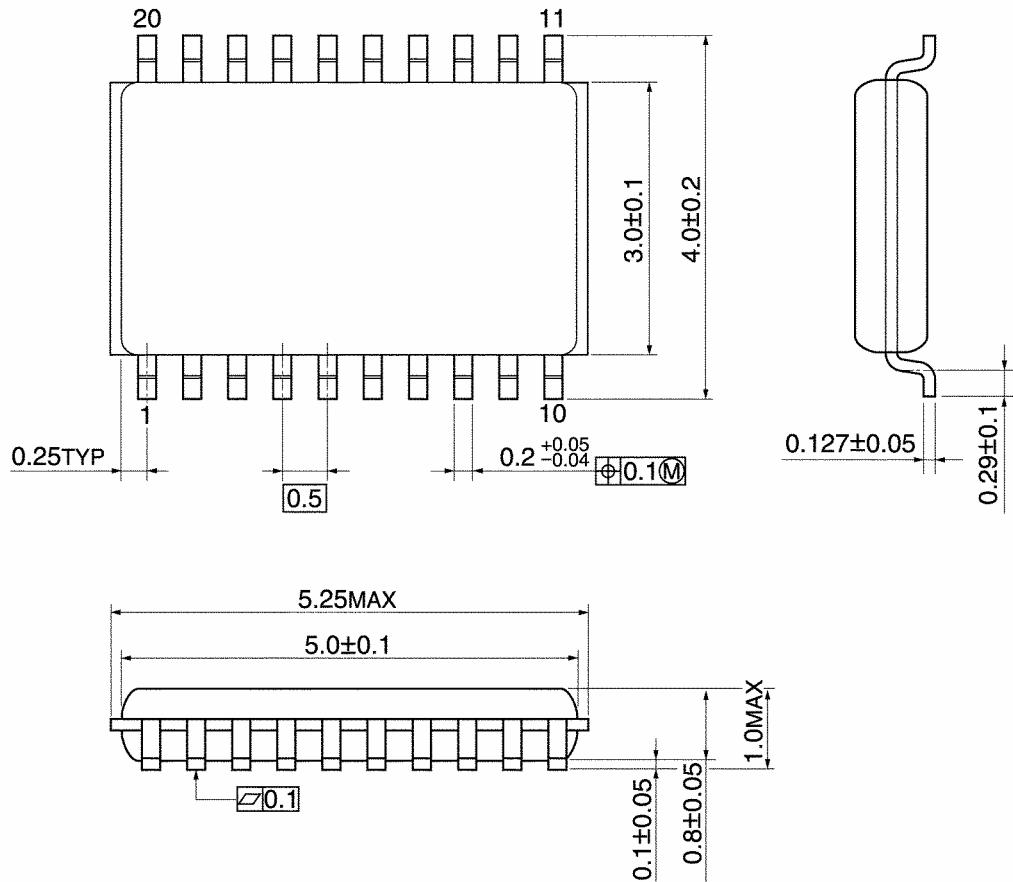


Weight: 0.08 g (typ.)

Package Dimensions

VSSOP20-P-0030-0.50

Unit: mm



Weight: 0.03 g (Typ.)

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